

#### US00D345510S

## United States Patent [19]

### Osamu

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[45] Date of Patent: \*\* Mar. 29, 1994

### MOLD TEMPERATURE CONTROLLER [54] Matsui Osamu, Osaka, Japan [75] Inventor: Assignee: Matsui Manufacturing Co., Ltd., [73] Osaka, Japan The portion of the term of this patent Notice: subsequent to Mar. 15, 2008 has been disclaimed. 14 Years Term: [21] Appl. No.: 723,518 [22] Filed: Jun. 28, 1991 Foreign Application Priority Data [30]

425/144, 143; D10/490, 50-52; D15/135

# [56] References Cited U.S. PATENT DOCUMENTS

Primary Examiner—Nelson C. Holtje Assistant Examiner—Antoine D. Davis Attorney, Agent, or Firm—Koda and Androlia

[57] CLAIM

The ornamental design for a mold temperature controller, as shown and described.

#### **DESCRIPTION**

FIG. 1 is a front elevational view of the mold temperature controller showing my new design;

FIG. 2 is a rear elevational view thereof;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a right side elevational view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof;

FIG. 7 is a perspective view taken from the top, front and right side of the mold temperature controller; and, FIG. 8 is a perspective view taken from the top, rear and left side of the mold temperature controller.

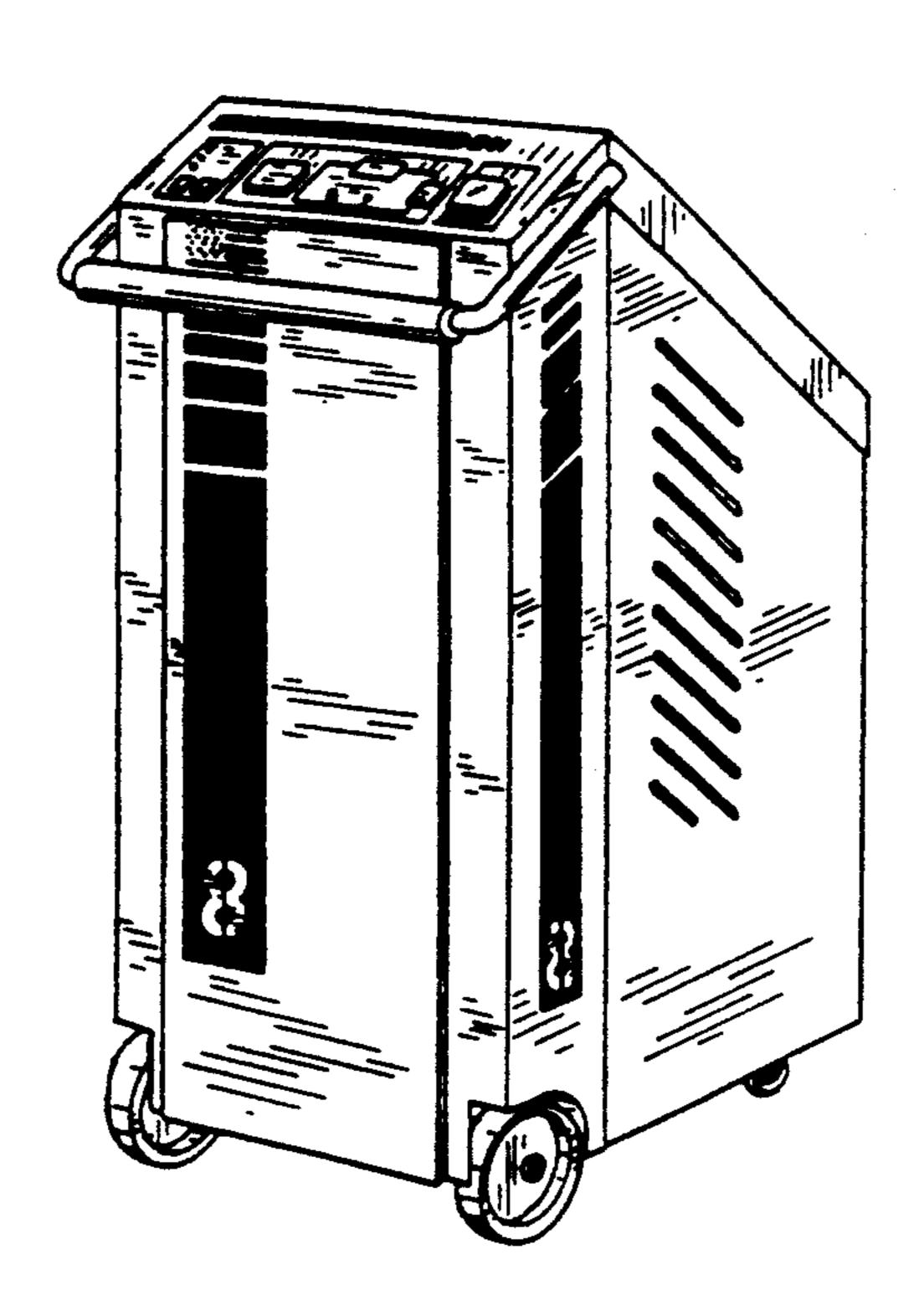


FIG. 1

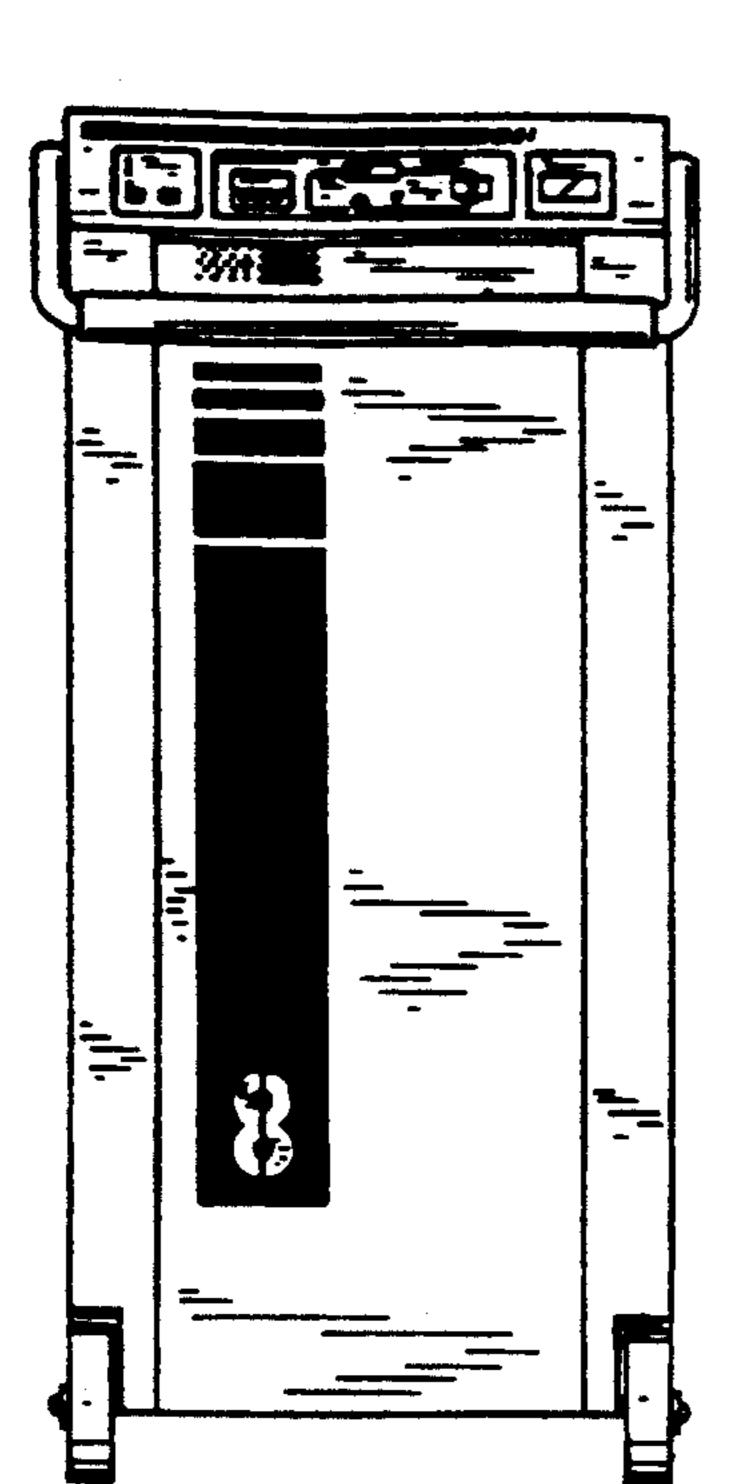


FIG. 3

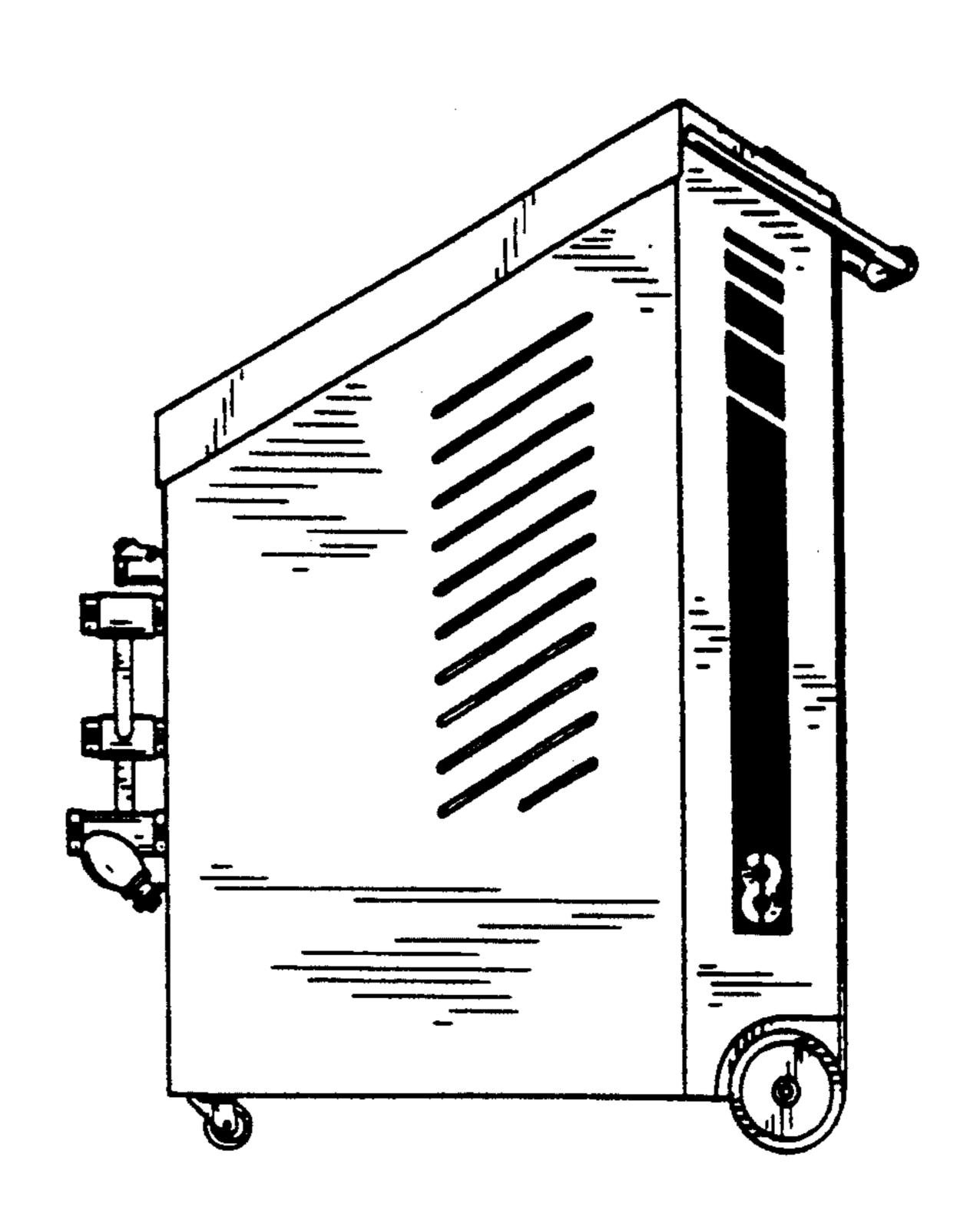


FIG. 2

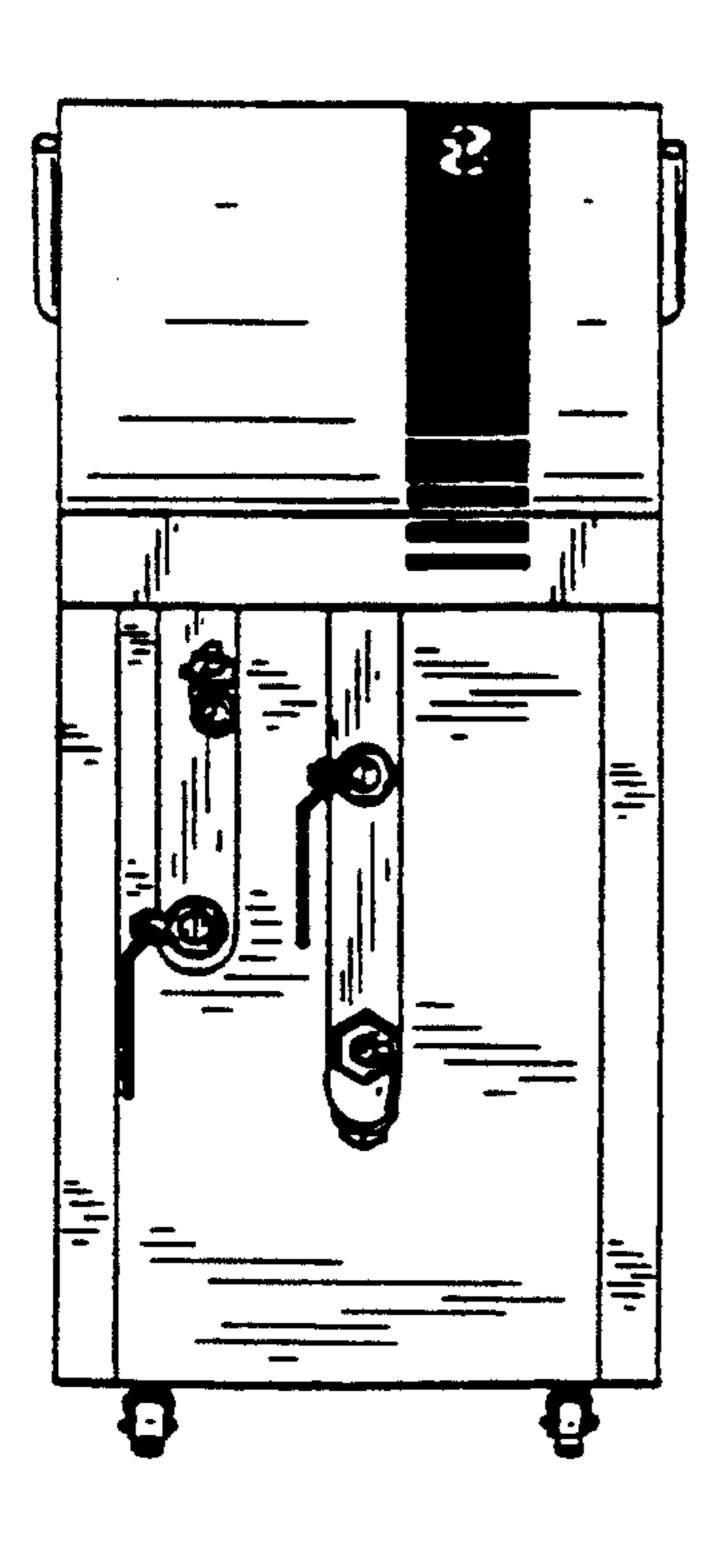


FIG. 4

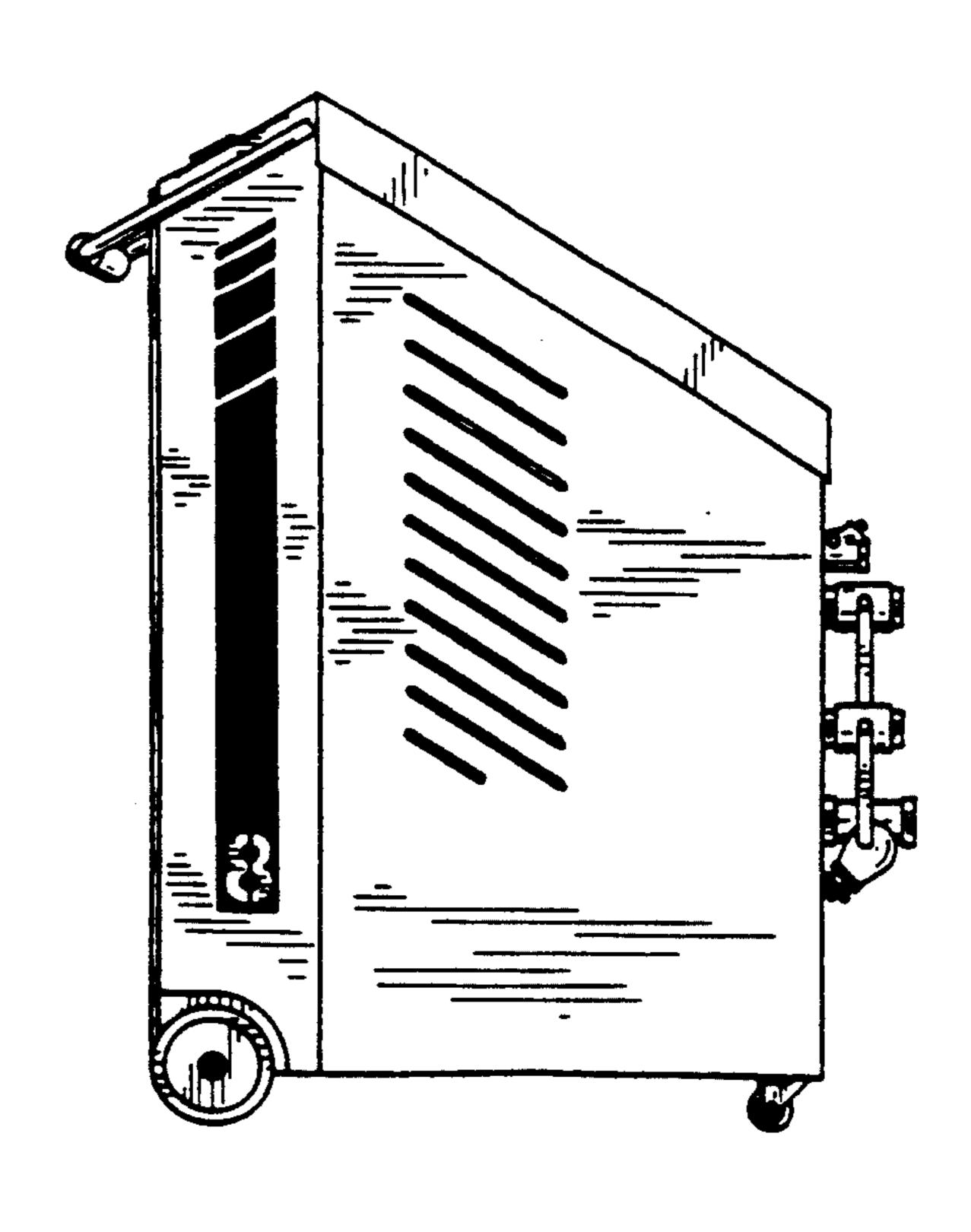


FIG. 7

FIG. 5

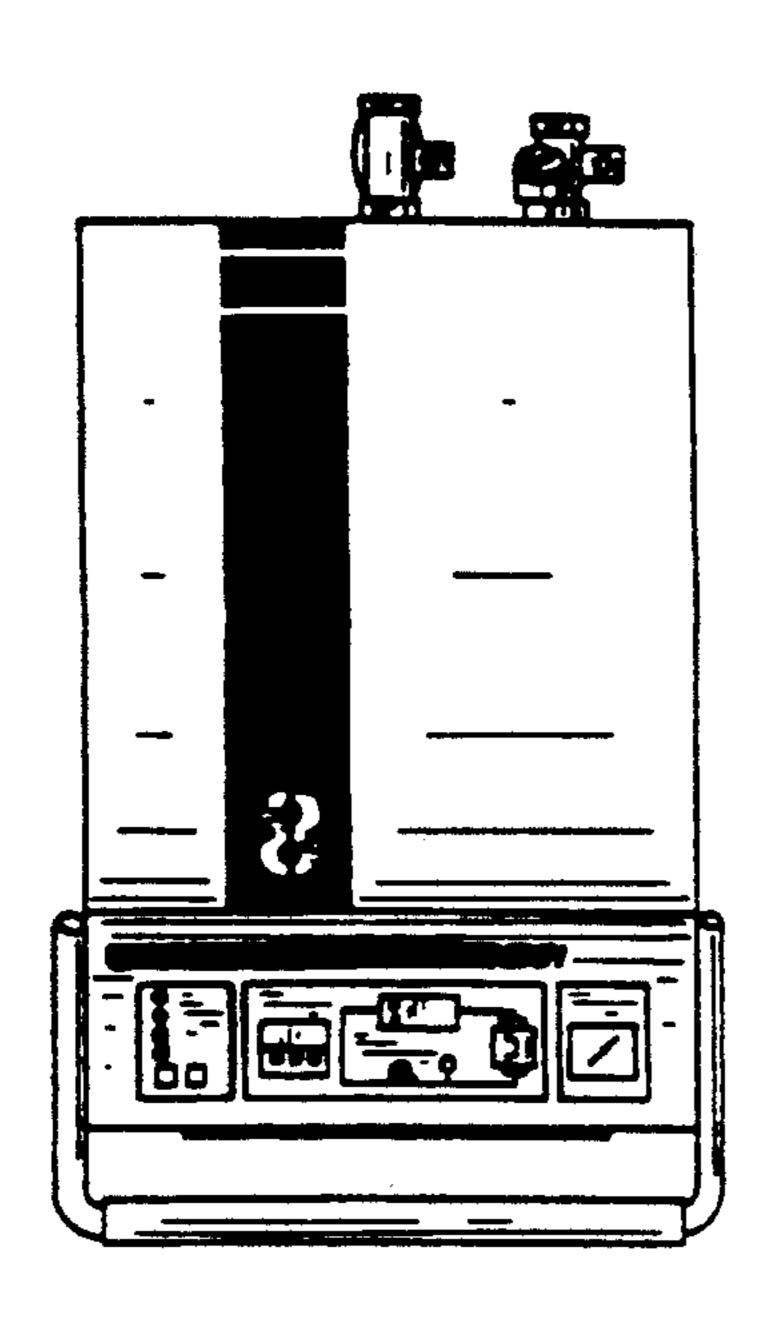


FIG. 6

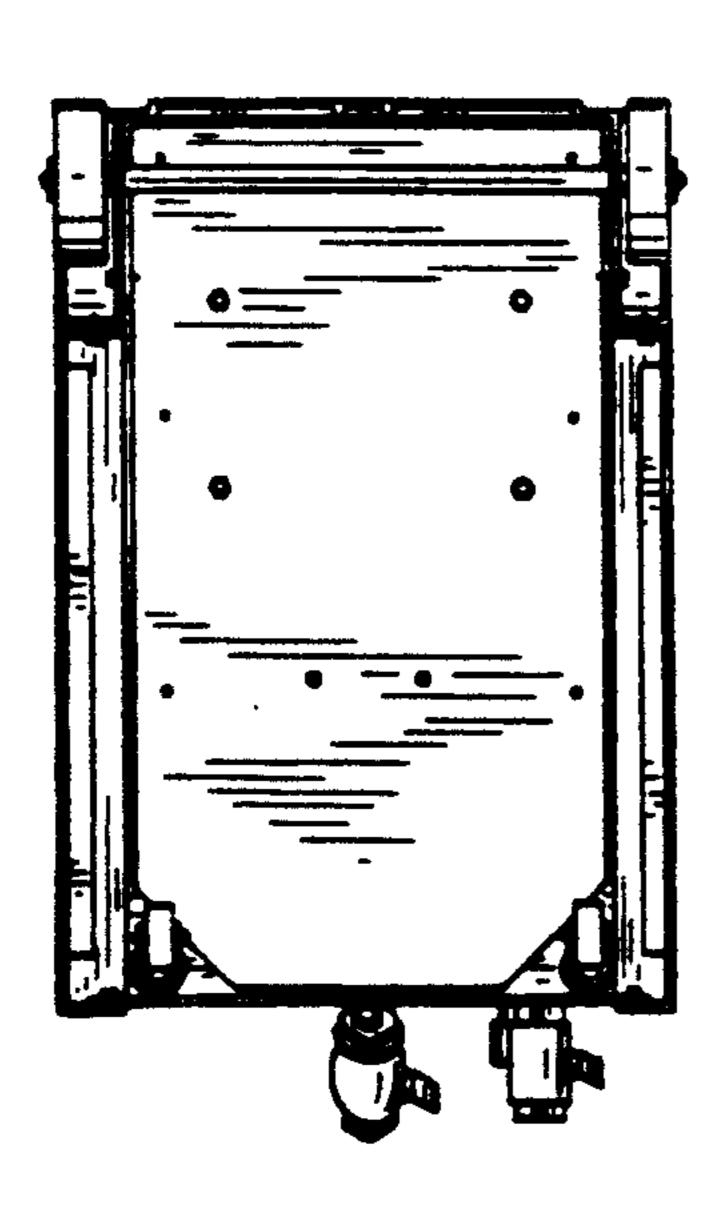


FIG. 8

